

A	2018-1				

B 2021-6-

/ Descriptions

50V~1000V 1.0A SMA
Surface Mount General Purpose Silicon Rectifiers, Reverse Voltage 50 to1000V,Forward
Current:1.0A ,SMA package.

/ Features

RoHS 2011/65/EU
Glass Passivated Chip Junction, Lead free in comply with EU RoHS 2011/65/EU directives, For
surface mounted applications. HF product.

/ Applications

General purpose.

/ Equivalent Circuit



/ Pinning

1  2

PIN	DESCRIPTION
1	Cathode

The recommended mounting and size

/ Marking

See Marking Instructions.

/ Absolute Maximum Ratings(Ta=25)

参数 Parameter	符号 Symbol	数值 Rating							单位 Unit
		S1A	S1B	S1D	S1G	S1J	S1K	S1M	
Maximum Repetitive Peak Reverse Voltage	V_{RRM}	50	100	200	400	600	800	1000	V
Maximum RMS voltage	V_{RMS}	35	70	140	280	420	560	700	V
Maximum DC Blocking Voltage	V_{DC}	50	100	200	400	600	800	1000	V
Maximum Average Forward Rectified Current	$I_F (AV)$	1.0							A
Peak Forward Surge Current 8.3 ms Single Half Sine Wave Superimposed on Rated Load	I_{FSM}	30							A
Typical Junction Capacitance at $V_R=4V$ $f=1MHz$	C_j	15							pF
Typical Thermal Resistance ¹⁾	$R_{\theta JA}$	75							°C/W
Operating and Storage Temperature Range	T_j, T_{stg}	-55~+150							°C

Note:

1) P.C.B. mounted with 2.0 X 2.0" (5 X5cm) copper pad areas.

/ Electrical Characteristics(Ta=25)

参数 Parameter	符号 Symbol	测试条件 Test Conditions	数值 Rating							单位 Unit
			S1A	S1B	S1D	S1G	S1J	S1K	S1M	
Maximum Instantaneous Forward Voltage	V_F	$I_F=1.0A$	1.1							V
Maximum DC Reverse Current at Rated DC Blocking Voltage	I_R	$T_a=25^{\circ}C$	5.0							μA
		$T_a=125^{\circ}C$	50							μA

/ Electrical Characteristic Curve

Fig.1 Forward Current Derating Curve

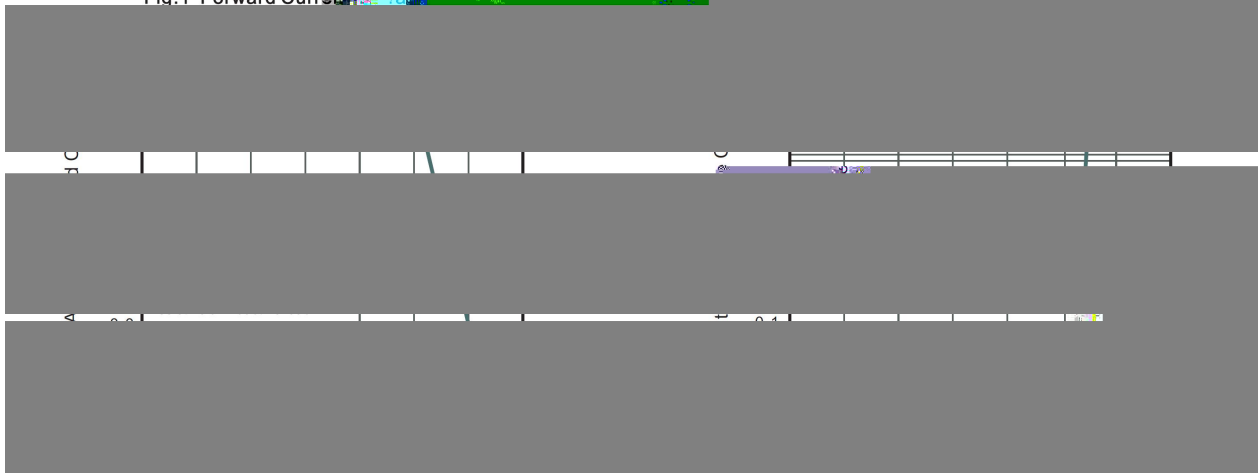


Fig.2 Typical Reverse Characteristics

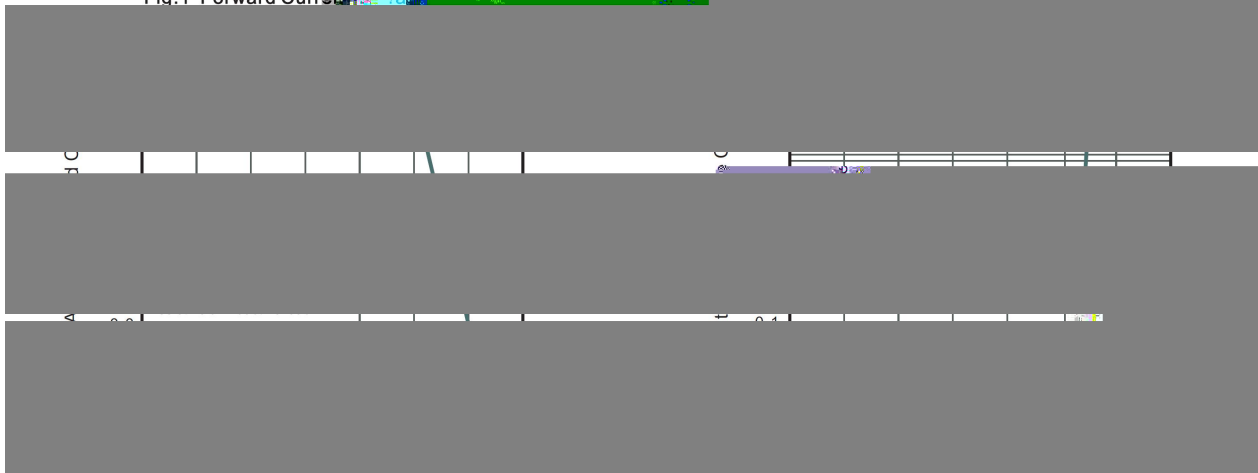


Fig.3 Typical Forward Characteristics

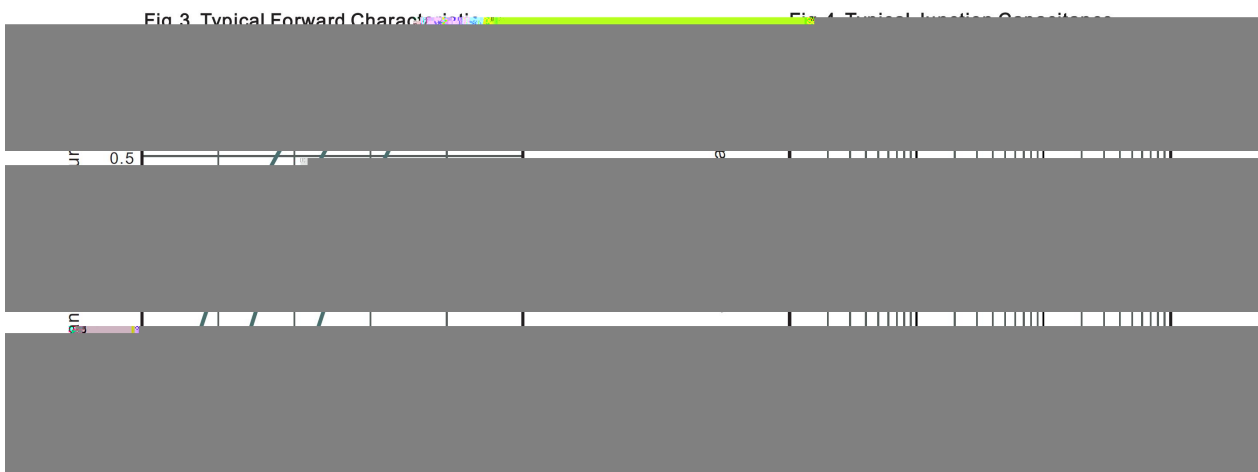
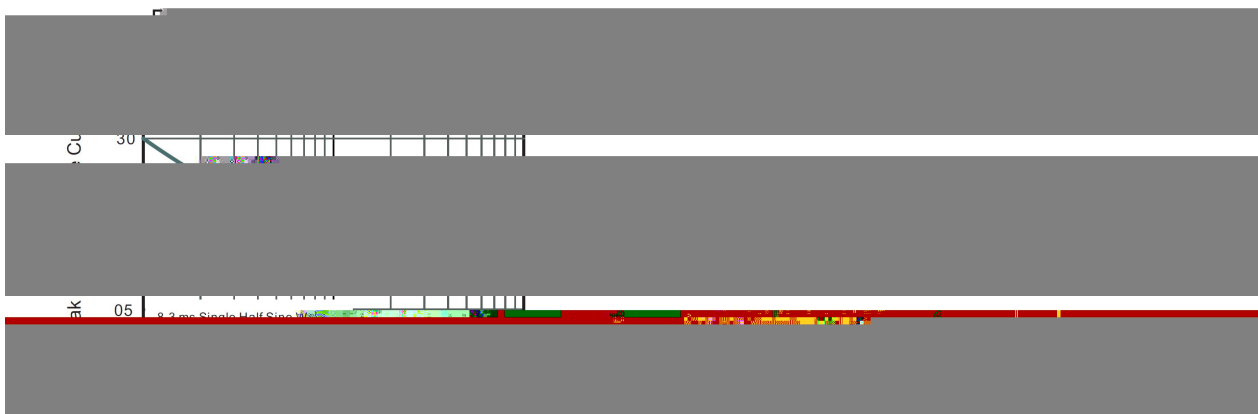
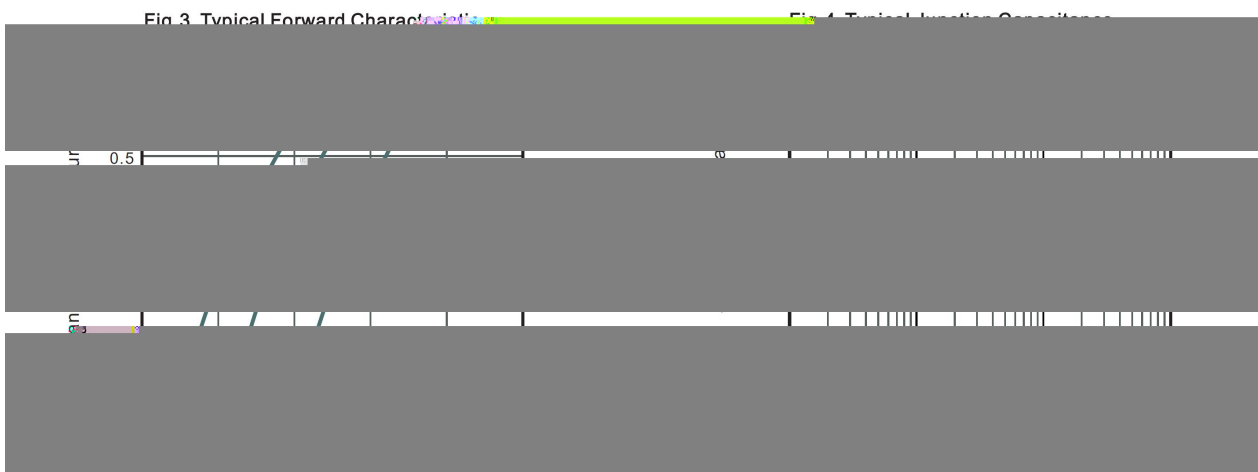
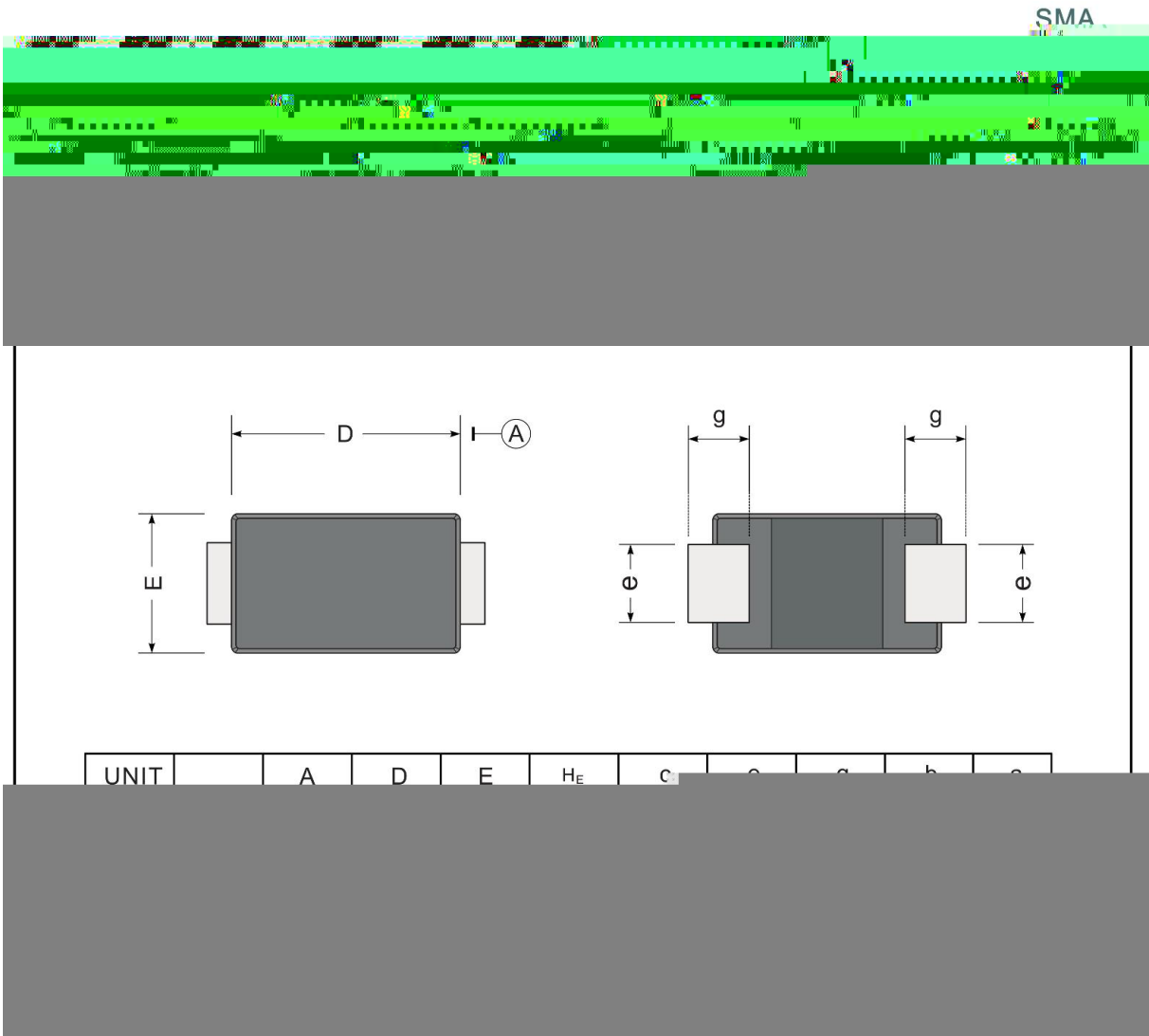
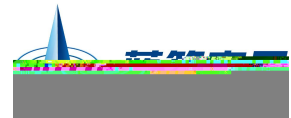


Fig.4 Typical Junction Capacitance



/ Package Dimensions



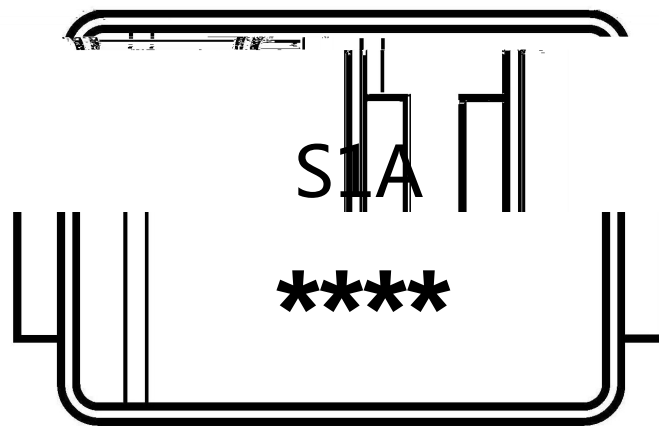


/ Marking Instructions

Marking



/ Marking Instructions



S1A

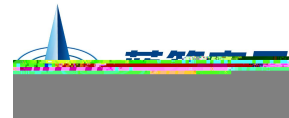
1 *

3 *

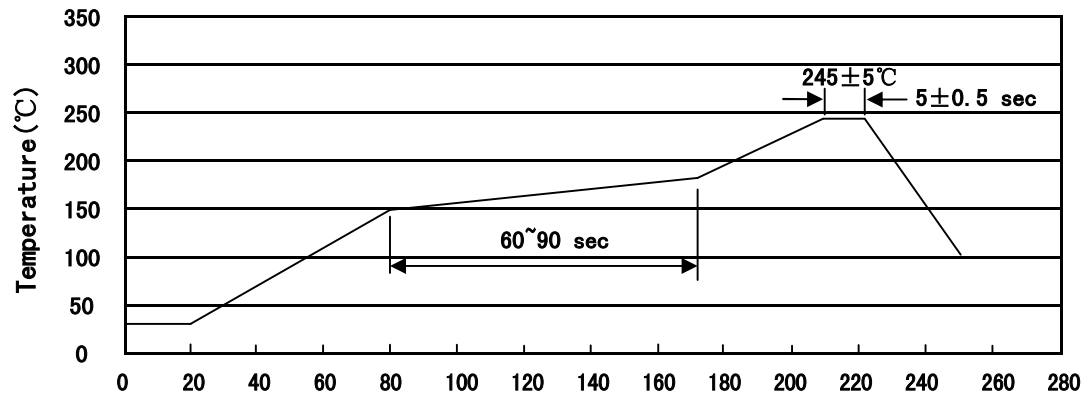
Note:

S1A Product Type Code

***** Lot No. Code The 1st * means:YM Code The last 3 * means:little Lot No Code



() / Temperature Profile for IR Reflow Soldering(Pb-Free)



Note:

- | | | | | | |
|---|-------|-----|----|-----------|--|
| 1 | 150 | 180 | 60 | 90sec; | 1.Preheating:150~180°C, Time:60~90sec. |
| 2 | 245±5 | | | 5±0.5sec; | 2.Peak Temp.:245±5°C, Duration:5±0.5sec. |
| 3 | | | 2 | 10°C/sec. | 3. Cooling Speed: 2~10°C/sec. |

/ Resistance to Soldering Heat Test Conditions

260±5°C 10±1 sec. Temp.:260±5°C Time:10±1 sec

/ Packaging SPEC.

/ REEL

Package Type	Units					Dimension (unit mm ³)		
	只 卷盘	卷盘 盒	只 盒	盒 箱	只 箱			
SMA	5000	2	10000	7	70000	13" ×12	336X336X40	380X335X366

/ Notices